

## **Power Schottky rectifier**

## **Technical Literature**

#### **CUSTOM ATTRIBUTES**

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#### **DOCUMENT HISTORY**

Version	Release Date	Change Qualifier	
Rev 6.1		Document change	
07/01/2014 AUTOMATIC REVALIDATION DATE WORKFLOW STARTED			



#### DOCUMENT APPROVAL

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## STPS41L60C

## Power Schottky rectifier

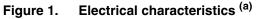
### Features

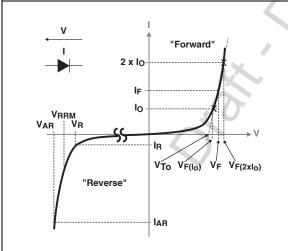
- Low forward voltage drop
- Negligible switching losses
- Low thermal resistance
- Avalanche capability specified

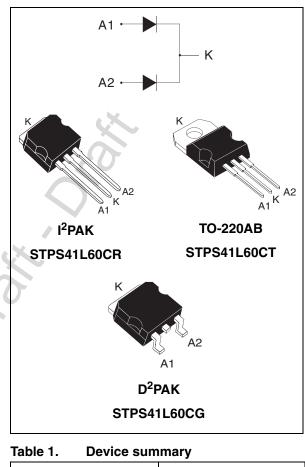
## Description

These dual center tap Schottky rectifiers are suited for switch mode power supplies and high frequency DC to DC converters.

Packaged in D<sup>2</sup>PAK, I<sup>2</sup>PAK and TO-220AB, this device is intended for use in low voltage, high frequency inverters, free-wheeling and polarity protection applications.







	-
I <sub>F(AV)</sub>	2 x 20 A
V <sub>RRM</sub>	60 V
T <sub>j (max)</sub>	150 °C
V <sub>F (max)</sub>	0.58 V

a. V<sub>ARM</sub> and I<sub>ARM</sub> must respect the reverse safe operating area defined in *Figure 12* V<sub>AR</sub> and I<sub>AR</sub> are pulse measurements (t<sub>p</sub> < 1 µs). V<sub>R</sub>, I<sub>R</sub>, V<sub>RRM</sub> and V<sub>F</sub>, are static characteristics

## 1 Characteristics

#### Table 2. Absolute ratings (limiting values, per diode)

Symbol	Parameter			Value	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage			60	V
I <sub>F(RMS)</sub>	Forward rms current			30	А
I <sub>F(AV)</sub>	Average forward current	$ \begin{array}{ll} T_{C} = 125 \ ^{\circ}C & \mbox{Per diode} \\ \delta = 0.5 & \mbox{Per device} \end{array} $		20 40	A
I <sub>FSM</sub>	Surge non repetitive forward current	tp = 10 ms Sinusoidal		220	А
P <sub>ARM</sub> <sup>(1)</sup>	Repetitive peak avalanche power	$tp = 1 \ \mu s \ T_j = 2$	5 °C	9500	W
V <sub>ARM</sub> <sup>(2)</sup>	Maximum repetitive peak avalanche voltage	t <sub>p</sub> < 1 μs, T <sub>j</sub> < 1	50 °C, I <sub>AR</sub> < 35 A	80	V
$V_{ASM}$ <sup>(2)</sup>	Maximum single pulse peak avalanche voltage	t <sub>p</sub> < 1 μs, T <sub>j</sub> < 1	50 °C, I <sub>AR</sub> < 35 A	80	V
T <sub>stg</sub>	Storage temperature range		0	-65 to + 175	°C
Тj	Maximum operating junction temperature <sup>(3)</sup>			150	°C

1. For temperature or pulse time duration deratings, refer to *Figure 4* and *Figure 5*. More details regarding the avalanche energy measurements and diode validation in the avalanche are provided in the application notes AN1768 and AN2025.

2. Refer to *Figure 12* 

3.  $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

#### Table 3. Thermal resistances

Symbol	Paramete	er	Value	Unit
R <sub>th (j-c)</sub>	Junction to case	Per diode Total	1.5 0.8	° C/W
R <sub>th (c)</sub>	Coupling		0.1	<b>C</b> /11

When the diodes 1 and 2 are used simultaneously :  $\Delta$ Tj(diode 1) = P(diode1) x R<sub>th(i-c)</sub>(Per diode) + P(diode 2) x R<sub>th(c)</sub>

#### Table 4. Static electrical characteristics (per diode)

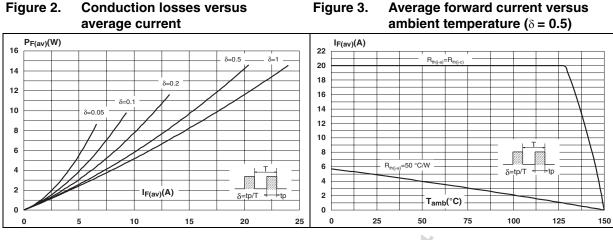
Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
ı (1)	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 25 °C	V - V			600	μA
'R `´		T <sub>j</sub> = 125 °C	$V_{R} = V_{RRM}$		100	175	mA
		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 20 A			0.60	
V <sub>F</sub> <sup>(1)</sup>		T <sub>j</sub> = 125 °C	I <sub>F</sub> = 20 A		0.50	0.58	V
V <sub>F</sub> <sup>(1)</sup> Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 40A			0.77	V	
		T <sub>j</sub> = 125 °C	I <sub>F</sub> = 40A		0.67	0.71	

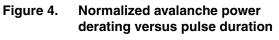
1. Pulse test:  $t_p$  = 380 µs,  $\delta$  < 2%

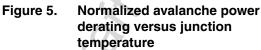
To evaluate the conduction losses use the following equation: P = 0.42 x  $I_{F(AV)}$  + 0.007 x  ${I_F}^2_{(RMS)}$ 

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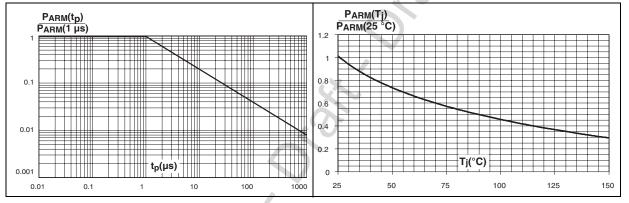
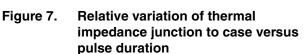
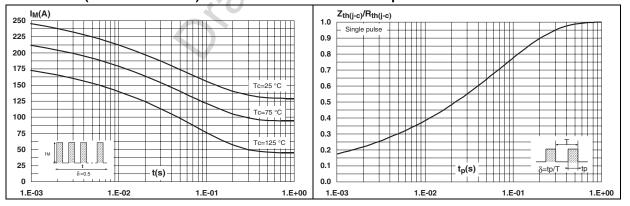


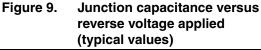
Figure 6. Non repetitive surge peak forward current versus overload duration (maximum values)

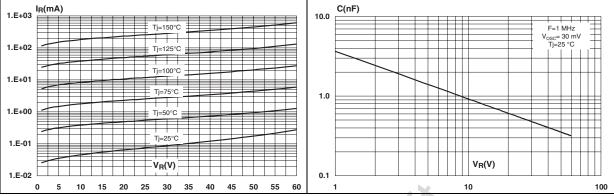




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# Figure 8. Reverse leakage current versus reverse voltage applied (typical values)





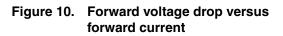


Figure 11. Thermal resistance junction to ambient versus copper surface under tab (STPS41L60CG only)

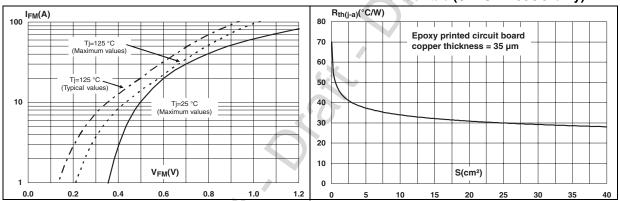
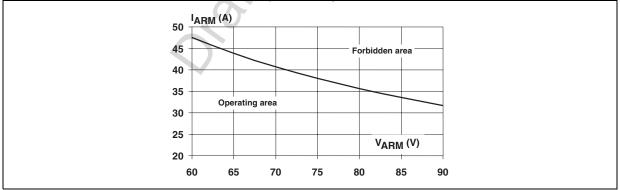


Figure 12. Reverse safe operating area ( $t_p < 1 \ \mu s$ ,  $T_i > 150 \ ^{\circ}C$ )



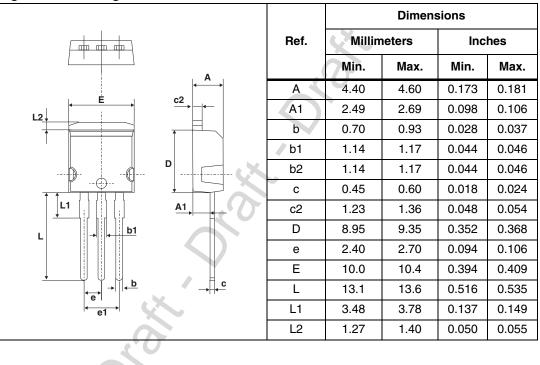


## 2 Package information

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

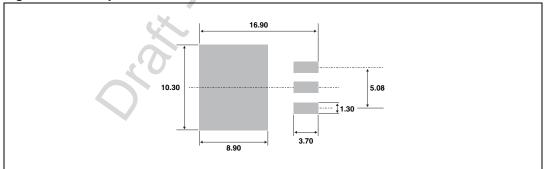
Figure 13. Package dimensions I<sup>2</sup>PAK



				Dimensi	ons	
				neters	Inc	hes
			Min.	Max.	Min.	Max.
		А	4.40	4.60	0.173	0.181
E		A1	2.49	2.69	0.098	0.106
		A2	0.03	0.23	0.001	0.009
	D	В	0.70	0.93	0.027	0.037
L		B2	1.14	1.70	0.045	0.067
	A1.	С	0.45	0.60	0.017	0.024
B2		C2	1.23	1.36	0.048	0.054
→ <b></b>		D	8.95	9.35	0.352	0.368
G→.		E	10.00	10.40	0.393	0.409
		G	4.88	5.28	0.192	0.208
	1.	L	15.00	15.85	0.590	0.624
	M * V2	L2	1.27	1.40	0.050	0.055
	* FLAT ZONE NO LESS THAN 2mm	L3	1.40	1.75	0.055	0.069
	0	М	2.40	3.20	0.094	0.126
	~~~~	R	0.40	typ.	0.010	6 typ.
		V2	0°	8°	0°	8°

Figure 14. Package dimensions D<sup>2</sup>PAK

#### Figure 15. Footprint





			Dimer	nsions	
	Ref.	Millim	neters	Inc	hes
		Min.	Max.	Min.	Max.
	А	4.40	4.60	0.173	0.181
H2 A	С	1.23	1.32	0.048	0.051
	D	2.40	2.72	0.094	0.107
	E	0.49	0.70	0.019	0.027
	F	0.61	0.88	0.024	0.034
	F1	1.14	1.70	0.044	0.066
L2	F2	1.14	1.70	0.044	0.066
	G	4.95	5.15	0.194	0.202
	G1	2.40	2.70	0.094	0.106
L4	H2	10	10.40	0.393	0.409
F→ ←	L2	16.4	typ.	0.64	5 typ.
	L4	13	14	0.511	0.551
G	L5	2.65	2.95	0.104	0.116
Cr.	L6	15.25	15.75	0.600	0.620
	L7	6.20	6.60	0.244	0.259
	L9	3.50	3.93	0.137	0.154
	М	2.6	typ.	0.102	2 typ.
	Diam.	3.75	3.85	0.147	0.151

Figure 16. Package dimensions TO-220AB



#### **Ordering information** 3

Table 5.	Ordering	information

Table 5. Oldell	ng mormation				
Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS41L60CG	STPS41L60CG	D <sup>2</sup> PAK	1.48 g	50	Tube
STPS41L60CG-TR	STPS41L60CG	D <sup>2</sup> PAK	1.48 g	1000	Tape and reel
STPS41L60CT	STPS41L60CT	TO-220AB	2.20 g	50	Tube
STPS41L60CR	STPS41L60CR	I <sup>2</sup> PAK	1.49 g	50	Tube

#### **Revision history** 4

Table 6.	Document revision history

Date	Revision	Changes
July 2003	ЗA	Previous issue
10-Jan-2007	4	Reformated to current standards. Added ECOPACK statement Removed I <sub>RRM</sub> and dV/dT from the Absolute ratings table on page 1. Updated reverse leakage current values in Table 3 and Figure 7.
28-May-2007	5	Updated figures 1, 2, and 5 to 10.
15-Jul-2011	6	Added electrical diagram on first page. Added parameters $V_{ARM}$ and $V_{ASM}$ to <i>Table 2</i> . Added <i>Figure 12</i> .



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